

## 1. General description

Dual ultrafast power diode in a SOT226A (I2PAK) low-profile plastic package.

## 2. Features and benefits

- High reverse voltage surge capability
- High thermal cycling performance
- Low thermal resistance
- Soft recovery characteristic minimizes power consuming oscillations
- Very low on-state loss

## 3. Applications

- Output rectifiers in high-frequency switched-mode power supplies

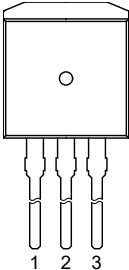
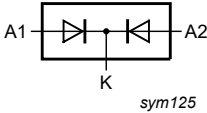
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V <sub>R</sub>	reverse voltage	DC		-	-	200	V
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> = 10 ms; T <sub>j(init)</sub> = 25 °C; SIN; per diode		-	-	150	A
		t <sub>p</sub> = 8.3 ms; T <sub>j(init)</sub> = 25 °C; SIN; per diode		-	-	160	A
Static characteristics							
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 15 A; T <sub>j</sub> = 150 °C; <a href="#">Fig. 4</a>		-	0.78	0.85	V
		I <sub>F</sub> = 15 A; T <sub>j</sub> = 25 °C; <a href="#">Fig. 4</a>		-	0.95	1.05	V
		I <sub>F</sub> = 30 A; T <sub>j</sub> = 25 °C; <a href="#">Fig. 4</a>		-	1	1.2	V
Dynamic characteristics							
t <sub>rr</sub>	reverse recovery time	I <sub>F</sub> = 1 A; V <sub>R</sub> = 30 V; dI <sub>F</sub> /dt = 100 A/μs; T <sub>j</sub> = 25 °C; ramp recovery; <a href="#">Fig. 5</a>		-	20	28	ns

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1	 <p>I2PAK (SOT226A)</p>	
2	K	cathode		
3	A2	anode 2		
mb	K	mounting base; connected to cathode		

6. Ordering information

Table 3. Ordering information

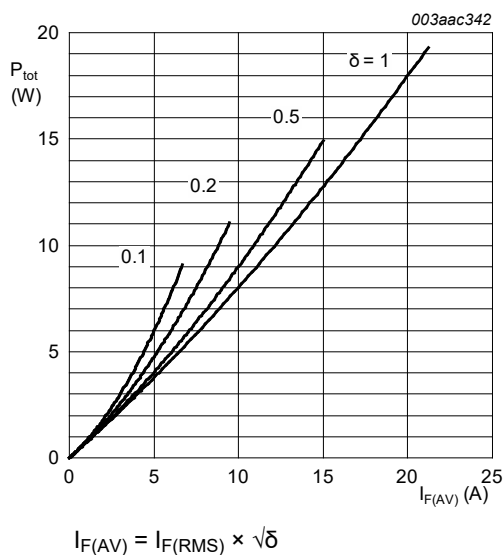
Type number	Package		
	Name	Description	Version
BYV42G-200	I2PAK	plastic single-ended package (I2PAK); TO-262	SOT226A

## 7. Limiting values

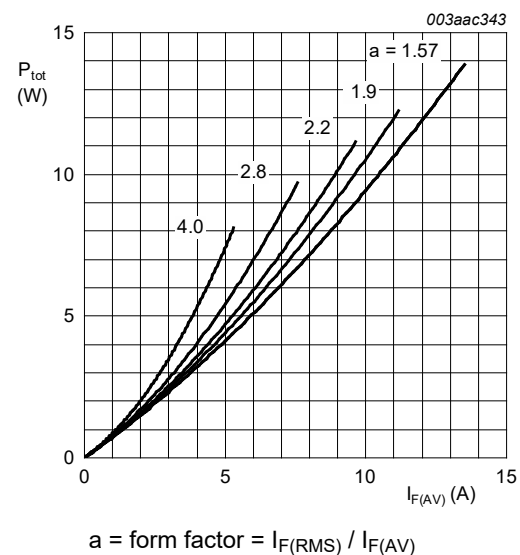
**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage		-	200	V
$V_{RWM}$	crest working reverse voltage		-	200	V
$V_R$	reverse voltage	DC	-	200	V
$I_{O(AV)}$	average output current	$\delta = 0.5$ ; $T_{mb} \leq 104\text{ }^{\circ}\text{C}$ ; SQW; both diodes conducting; Fig. 1; Fig. 2	-	30	A
$I_{FRM}$	repetitive peak forward current	$\delta = 0.5$ ; $t_p = 25\text{ }\mu\text{s}$ ; $T_{mb} \leq 104\text{ }^{\circ}\text{C}$ ; per diode	-	30	A
$I_{FSM}$	non-repetitive peak forward current	$t_p = 10\text{ ms}$ ; $T_{j(\text{init})} = 25\text{ }^{\circ}\text{C}$ ; SIN; per diode	-	150	A
		$t_p = 8.3\text{ ms}$ ; $T_{j(\text{init})} = 25\text{ }^{\circ}\text{C}$ ; SIN; per diode	-	160	A
$I_{RRM}$	repetitive peak reverse current	$\delta = 0.001$ ; $t_p = 2\text{ }\mu\text{s}$	-	0.2	A
$I_{RSM}$	non-repetitive peak reverse current	$t_p = 100\text{ }\mu\text{s}$	-	0.2	A
$T_{stg}$	storage temperature		-40	150	$^{\circ}\text{C}$
$T_j$	junction temperature		-	150	$^{\circ}\text{C}$
$V_{ESD}$	electrostatic discharge voltage	HBM; $C = 250\text{ pF}$ ; $R = 1.5\text{ k}\Omega$ ; all pins	-	8	kV



**Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values**



**Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values**

8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	with heatsink compound; both diodes conducting	-	-	1.4	K/W
		with heatsink compound; per diode; <a href="#">Fig. 3</a>	-	-	2.4	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W

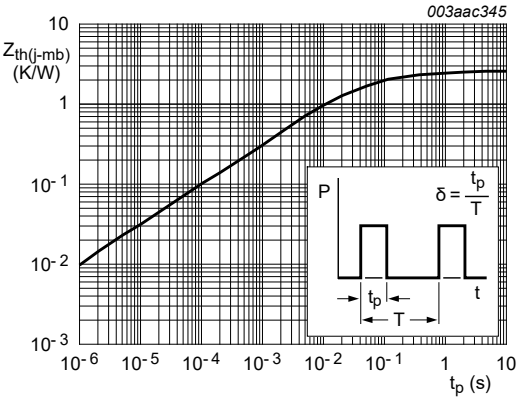


Fig. 3. Transient thermal impedance from junction to mounting base as a function of pulse width

9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 15 A; T <sub>j</sub> = 150 °C; <a href="#">Fig. 4</a>		-	0.78	0.85	V
		I <sub>F</sub> = 15 A; T <sub>j</sub> = 25 °C; <a href="#">Fig. 4</a>		-	0.95	1.05	V
		I <sub>F</sub> = 30 A; T <sub>j</sub> = 25 °C; <a href="#">Fig. 4</a>		-	1	1.2	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 200 V; T <sub>j</sub> = 100 °C		-	0.5	1	mA
		V <sub>R</sub> = 200 V; T <sub>j</sub> = 25 °C		-	10	100	μA
Dynamic characteristics							
t <sub>rr</sub>	reverse recovery time	I <sub>F</sub> = 1 A; V <sub>R</sub> = 30 V; dI <sub>F</sub> /dt = 100 A/μs; T <sub>j</sub> = 25 °C; ramp recovery; <a href="#">Fig. 5</a>		-	20	28	ns
		I <sub>F</sub> = 0.5 A; I <sub>R</sub> = 1 A; T <sub>j</sub> = 25 °C; step recovery; measured at reverse current = 0.25 A; <a href="#">Fig. 6</a>		-	13	22	ns
Q <sub>r</sub>	recovered charge	I <sub>F</sub> = 2 A; V <sub>R</sub> = 30 V; dI <sub>F</sub> /dt = 20 A/μs; T <sub>j</sub> = 25 °C		-	6	15	nC
V <sub>FR</sub>	forward recovery voltage	I <sub>F</sub> = 1 A; dI <sub>F</sub> /dt = 10 A/μs; T <sub>j</sub> = 25 °C; <a href="#">Fig. 7</a>		-	-	1	V

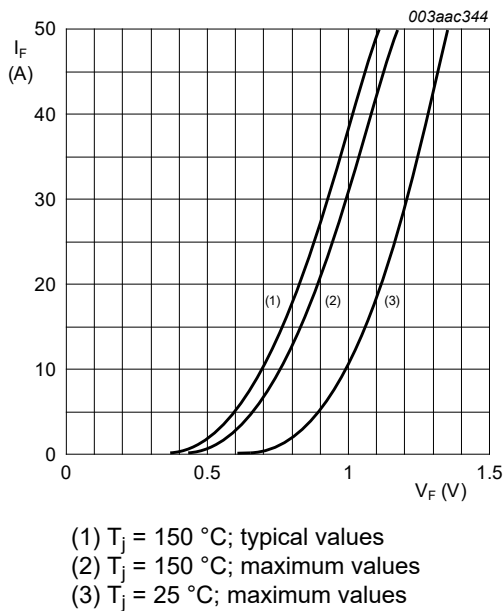


Fig. 4. Forward current as a function of forward voltage

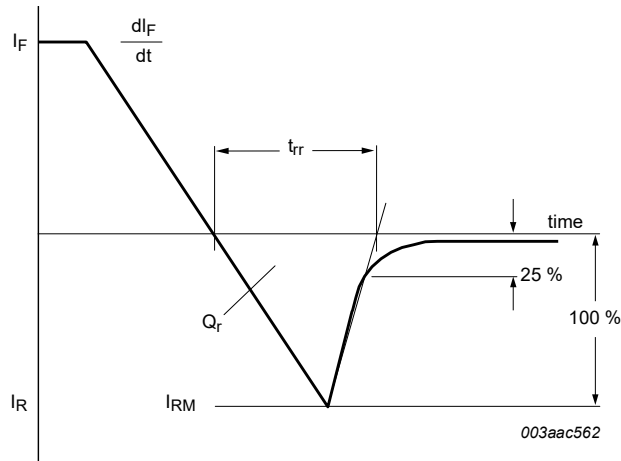
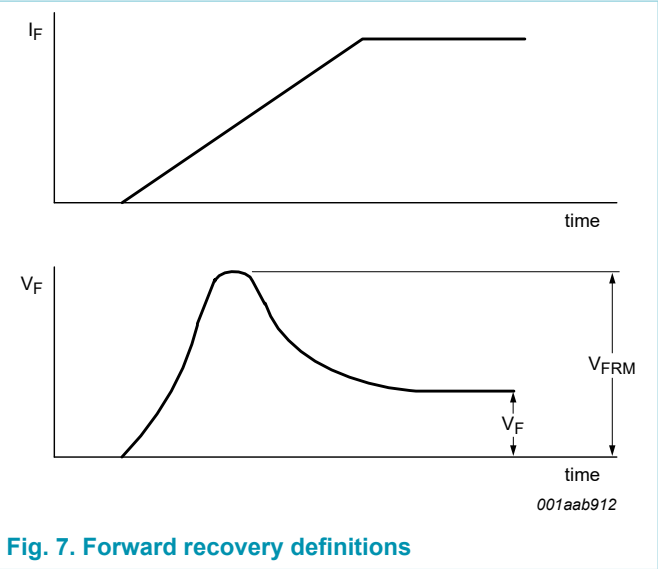
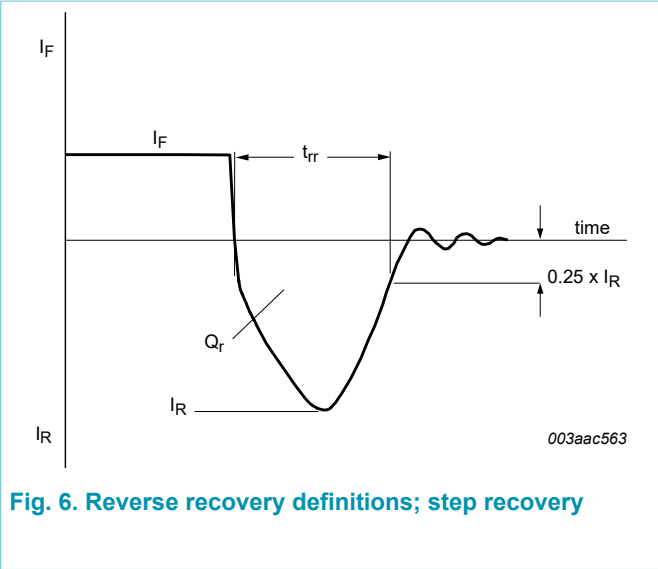
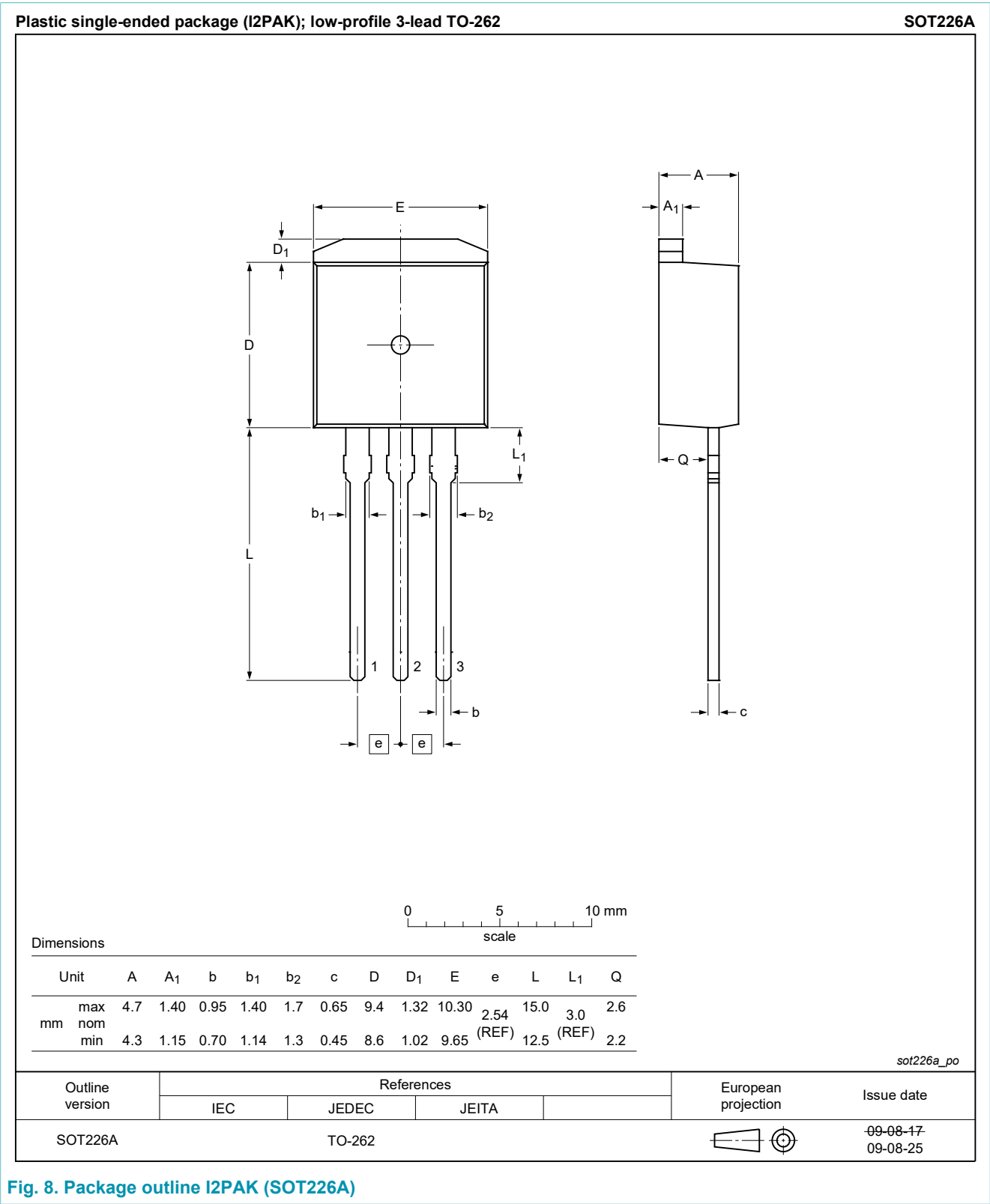


Fig. 5. Reverse recovery definitions; ramp recovery



10. Package outline



## 11. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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